



Vincotech

10-P106PPA050SJ-PD54B09Y

datasheet

flowPIM 1 + PFC

600 V / 50 A

Topology features

- Open Emitter configuration
- Temperature sensor
- On-board Capacitors
- Converter + 2-leg interleaved PFC + Inverter
- 2x Shunts

Component features

- 5us short circuit withstand time
- High speed switching
- Low EMI
- Short tail current

Housing features

- Base isolation: Al₂O₃
- Convex shaped substrate for superior thermal contact
- Thermo-mechanical push-and-pull force relief
- Press-fit pin
- Reliable cold welding connection

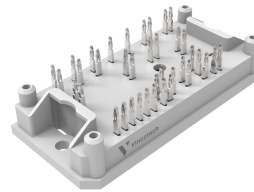
Target applications

- Embedded Drives
- Heat Pumps
- HVAC
- Industrial Drives

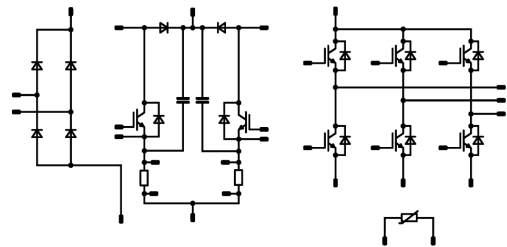
Types

- 10-P106PPA050SJ-PD54B09Y

flow 1 17 mm housing



Schematic





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Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Inverter Switch				
Collector-emitter voltage	V_{CES}		600	V
Collector current (DC current)	I_C	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	48	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	150	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	79	W
Gate-emitter voltage	V_{GES}		± 20	V
Short circuit ratings	t_{SC}	$V_{GE} = 15\text{ V}$, $V_{CC} = 400\text{ V}$ $T_j = 150\text{ °C}$	5	μs
Maximum junction temperature	T_{jmax}		175	$^{\circ}\text{C}$

Inverter Diode

Peak repetitive reverse voltage	V_{RRM}		600	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	33	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	60	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	52	W
Maximum junction temperature	T_{jmax}		175	$^{\circ}\text{C}$

PFC Switch

Collector-emitter voltage	V_{CES}		650	V
Collector current (DC current)	I_C	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	41	A
Repetitive peak collector current	I_{CRM}	t_p limited by T_{jmax}	120	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	73	W
Gate-emitter voltage	V_{GES}		± 20	V
Maximum junction temperature	T_{jmax}		175	$^{\circ}\text{C}$



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Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
PFC Diode				
Peak repetitive reverse voltage	V_{RRM}		600	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	55	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	120	A
Surge (non-repetitive) forward current	I_{FSM}	Single Half Sine Wave, $t_p = 10\text{ ms}$ $T_j = 25\text{ °C}$	480	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	76	W
Maximum junction temperature	T_{jmax}		175	°C

PFC Sw. Protection Diode

Peak repetitive reverse voltage	V_{RRM}		650	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s \leq 80\text{ °C}$	20 ⁽¹⁾	A
Repetitive peak forward current	I_{FRM}	t_p limited by T_{jmax}	20	A
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	33	W
Maximum junction temperature	T_{jmax}		175	°C

⁽¹⁾ limited by I_{FRM}

Rectifier Diode

Peak repetitive reverse voltage	V_{RRM}		1600	V
Forward current (DC current)	I_F	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	86	A
Surge (non-repetitive) forward current	I_{FSM}	Single Half Sine Wave, $t_p = 10\text{ ms}$ $T_j = 150\text{ °C}$	890	A
Surge current capability	I^2t		3960	A ² s
Total power dissipation	P_{tot}	$T_j = T_{jmax}$ $T_s = 80\text{ °C}$	91	W
Maximum junction temperature	T_{jmax}		150	°C

PFC Shunt

DC current	I		31,6	A
Power dissipation	P_{tot}	$T_c = 70\text{ °C}$	2	W
Operation Temperature	T_{op}		-65 ... 170	°C



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Maximum Ratings

$T_j = 25\text{ °C}$, unless otherwise specified

Parameter	Symbol	Conditions	Value	Unit
Capacitor (PFC)				
Maximum DC voltage	V_{MAX}		630	V
Operation Temperature	T_{op}		-55 ... 150	°C

Module Properties

Thermal Properties

Storage temperature	T_{stg}		-40...+125	°C
Operation temperature under switching condition	T_{jop}		-40...+($T_{jmax} - 25$)	°C

Isolation Properties

Isolation voltage	V_{isol}	DC Test Voltage* $t_p = 2\text{ s}$	6000	V
Isolation voltage	V_{isol}	AC Voltage $t_p = 1\text{ min}$	2500	V
Creepage distance			>12.7mm	mm
Clearance			7.82mm	mm
Comparative Tracking Index	CTI		≥ 600	

*100 % tested in production



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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max	

Inverter Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,0008	25	4,1	5,1	5,7	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		50	25 125 150		1,49 1,61 1,64	1,8 ⁽²⁾	V
Collector-emitter cut-off current	I_{CES}		0	600		25			2,8	µA
Gate-emitter leakage current	I_{GES}		20	0		25			100	nA
Internal gate resistance	r_g							None		Ω
Input capacitance	C_{ies}	$f = 1 \text{ Mhz}$	0	25		25		1950		pF
Output capacitance	C_{oes}							83		pF
Reverse transfer capacitance	C_{res}							67		pF
Gate charge	Q_g	$V_{CC} = 480 \text{ V}$	15		50	25		249		nC

Thermal

Thermal resistance junction to sink ⁽³⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						1,2		K/W
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Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 8 \Omega$ $R_{goff} = 8 \Omega$	± 15	350	50	25 125 150		70 70 71,2		ns
Rise time	t_r					25 125 150		45,2 43,2 42,8		ns
Turn-off delay time	$t_{d(off)}$					25 125 150		114,8 133,6 138,6		ns
Fall time	t_f					25 125 150		22,47 34,2 41,12		ns
Turn-on energy (per pulse)	E_{on}					25 125 150		1,84 2,2 2,28		mWs
Turn-off energy (per pulse)	E_{off}					25 125 150		0,536 0,839 0,941		mWs



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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max	

Inverter Diode

Static

Forward voltage	V_F				30	25 150	1,25	1,64 1,55	1,95 ⁽²⁾	V
Reverse leakage current	I_R	$V_r = 600$ V				25			27	μA

Thermal

Thermal resistance junction to sink ⁽³⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,81		K/W
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Dynamic

Peak recovery current	I_{RM}	$di/dt=245$ A/μs $di/dt=545$ A/μs $di/dt=378$ A/μs	±15	350	50	25 125 150		10,63 16,09 16,77		A
Reverse recovery time	t_{rr}					25 125 150		251,47 331,66 392,82		ns
Recovered charge	Q_r					25 125 150		1,62 3,09 3,57		μC
Reverse recovered energy	E_{rec}					25 125 150		0,406 0,762 0,892		mWs
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					25 125 150		76,03 88,46 100,72		A/μs



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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max	

PFC Switch

Static

Gate-emitter threshold voltage	$V_{GE(th)}$	$V_{CE} = V_{GE}$			0,0004	25	3,3	4	4,7	V
Collector-emitter saturation voltage	$V_{CE(sat)}$		15		40	25 125 150		1,54 1,69 1,74	2,22 ⁽²⁾	V
Collector-emitter cut-off current	I_{CES}		0	650		25			80	μA
Gate-emitter leakage current	I_{GES}		20	0		25			240	nA
Internal gate resistance	r_g							None		Ω
Input capacitance	C_{ies}	$f = 1 \text{ Mhz}$	0	25		25		2400		pF
Output capacitance	C_{oes}							60		pF
Reverse transfer capacitance	C_{res}							10		pF
Gate charge	Q_g	$V_{CC} = 520 \text{ V}$	15		40	25		96		nC

Thermal

Thermal resistance junction to sink ⁽³⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4 \text{ W/mK}$ (PSX)						1,3		K/W
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Dynamic

Turn-on delay time	$t_{d(on)}$	$R_{gon} = 4 \Omega$ $R_{goff} = 4 \Omega$	0/15	400	50	25 125 150		14,85 14,55 14,29		ns
Rise time	t_r					25 125 150		8,26 9,49 9,93		ns
Turn-off delay time	$t_{d(off)}$					25 125 150		68,26 81,94 85,21		ns
Fall time	t_f					25 125 150		4,89 11,54 16,52		ns
Turn-on energy (per pulse)	E_{on}					25 125 150		0,434 0,676 0,765		mWs
Turn-off energy (per pulse)	E_{off}					25 125 150		0,307 0,471 0,527		mWs



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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max	

PFC Diode

Static

Forward voltage	V_F				60	25 125 150		1,89 1,57 1,5	2,5 ⁽²⁾	V
Reverse leakage current	I_R	$V_i = 600$ V				25			25	µA

Thermal

Thermal resistance junction to sink ⁽³⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						1,25		K/W
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Dynamic

Peak recovery current	I_{RM}	$di/dt=4573$ A/µs $di/dt=4683$ A/µs $di/dt=4623$ A/µs	0/15	400	50	25 125 150		57,46 98,57 112,75		A
Reverse recovery time	t_{rr}					25 125 150		24,63 35 38,46		ns
Recovered charge	Q_r					25 125 150		0,759 2,06 2,6		µC
Reverse recovered energy	E_{rec}					25 125 150		0,165 0,514 0,659		mWs
Peak rate of fall of recovery current	$(di_{rr}/dt)_{max}$					25 125 150		5595,29 6038,91 6707,51		A/µs



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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max	

PFC Sw. Protection Diode

Static

Forward voltage	V_F				10	25 125	1,23	1,67 1,54	1,87 ⁽²⁾	V
Reverse leakage current	I_R	$V_r = 650$ V				25			0,14	μA

Thermal

Thermal resistance junction to sink ⁽³⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						2,87		K/W
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Rectifier Diode

Static

Forward voltage	V_F				60	25 125 150		1,04 0,973 0,956	1,5 ⁽²⁾	V
Reverse leakage current	I_R	$V_r = 1600$ V				25 150			100 2	μA

Thermal

Thermal resistance junction to sink ⁽³⁾	$R_{th(j-s)}$	$\lambda_{paste} = 3,4$ W/mK (PSX)						0,77		K/W
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PFC Shunt

Static

Resistance	R							2		mΩ
Temperature coefficient	tc								275	ppm/K



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Characteristic Values

Parameter	Symbol	Conditions					Values			Unit
			V_{GE} [V] V_{GS} [V]	V_{CE} [V] V_{DS} [V] V_F [V]	I_C [A] I_D [A] I_F [A]	T_j [°C]	Min	Typ	Max	

Capacitor (PFC)

Static

Capacitance	C	DC bias voltage = 0 V				25		33		nF
Tolerance							-5		5	%

Thermistor

Static

Rated resistance	R					25		22		kΩ
Deviation of R100	$\Delta_{R/R}$	$R_{100} = 1484 \Omega$				100	-5		5	%
Power dissipation	P					25		130		mW
Power dissipation constant	d					25		1,5		mW/K
B-value	$B_{(25/50)}$	Tol. ± 1 %						3962		K
B-value	$B_{(25/100)}$	Tol. ± 1 %						4000		K
Vincotech Thermistor Reference									I	

⁽²⁾ Value at chip level

⁽³⁾ Only valid with pre-applied Vincotech thermal interface material.



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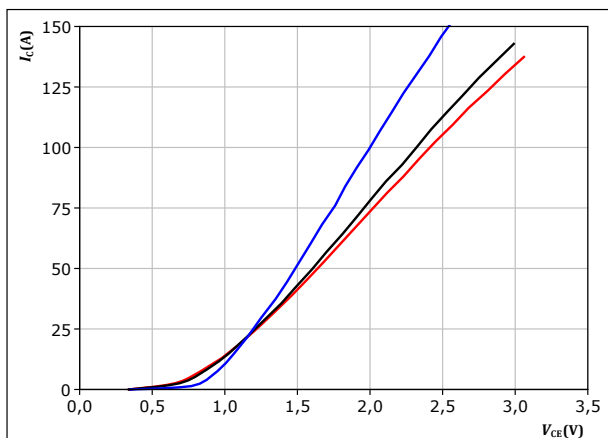
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Inverter Switch Characteristics

figure 1. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

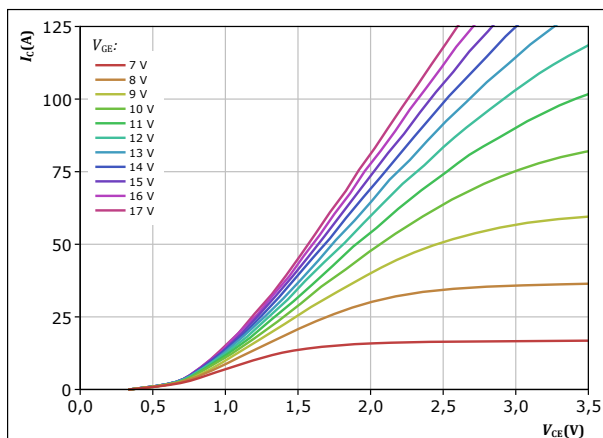


$t_p = 250 \mu s$
 $V_{GE} = 15 V$
 $T_j: 25 ^\circ C$
 $125 ^\circ C$
 $150 ^\circ C$

figure 2. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

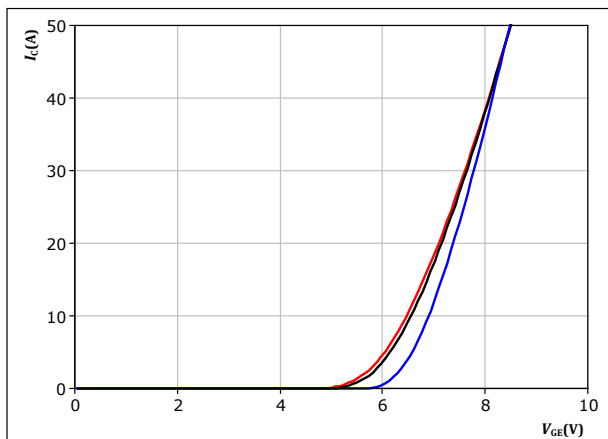


$t_p = 250 \mu s$
 $T_j = 150 ^\circ C$
 V_{GE} from 7 V to 17 V in steps of 1 V

figure 3. IGBT

Typical transfer characteristics

$$I_C = f(V_{GE})$$

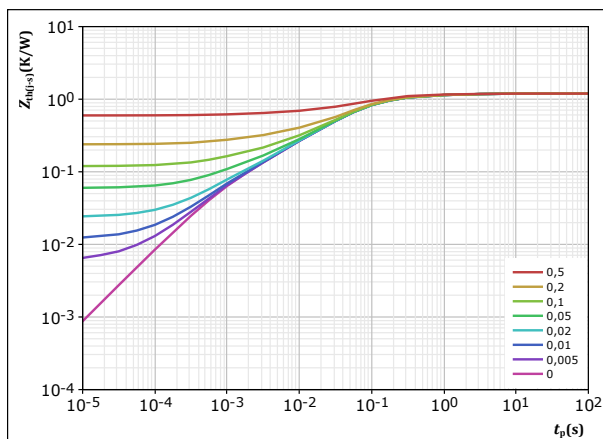


$t_p = 250 \mu s$
 $V_{CE} = 10 V$
 $T_j: 25 ^\circ C$
 $125 ^\circ C$
 $150 ^\circ C$

figure 4. IGBT

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 1,195 K/W$
IGBT thermal model values

$R (K/W)$	$\tau (s)$
7,02E-02	2,29E+00
1,93E-01	3,20E-01
7,24E-01	6,54E-02
1,54E-01	8,99E-03
5,44E-02	9,23E-04



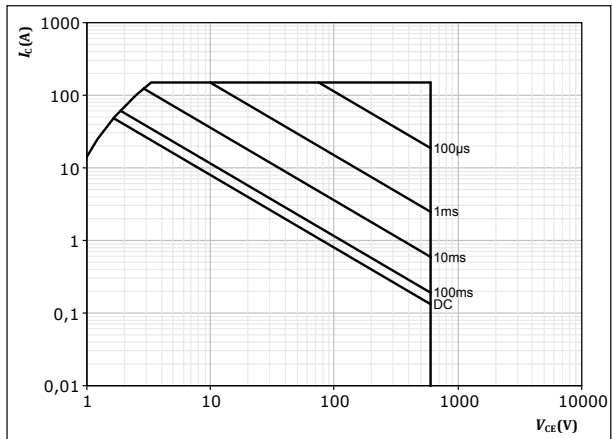
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Inverter Switch Characteristics

figure 5. IGBT

Safe operating area

$$I_C = f(V_{CE})$$



D = single pulse

$T_s = 80$ °C

$V_{GE} = 15$ V

$T_j = T_{jmax}$



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Inverter Diode Characteristics

figure 6.

FWD

Typical forward characteristics

$$I_F = f(V_F)$$

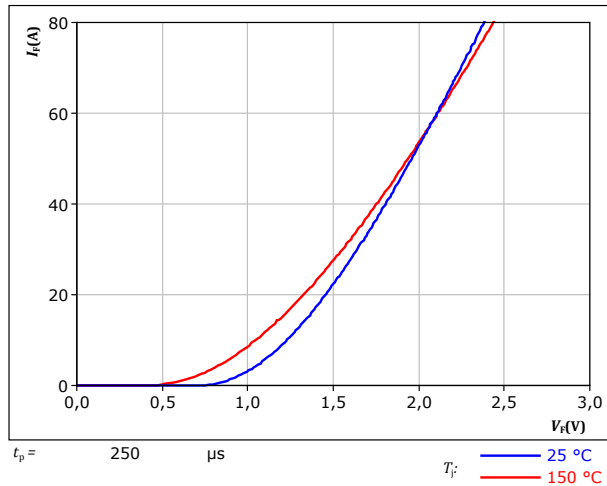
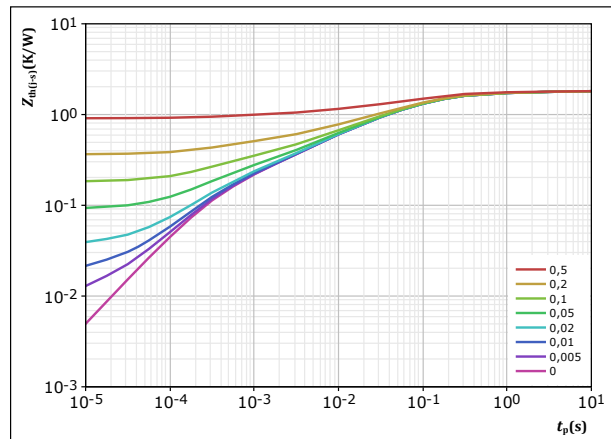


figure 7.

FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$





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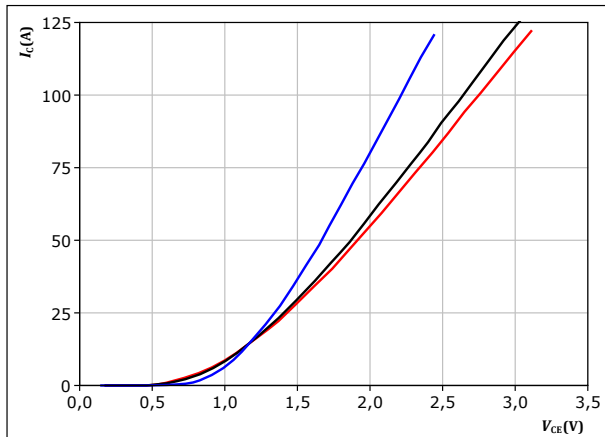
datasheet

PFC Switch Characteristics

figure 8. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

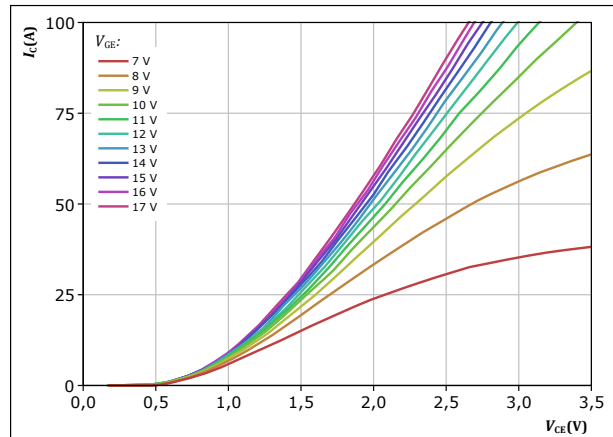


$t_p = 250 \mu s$
 $V_{GE} = 15 V$
 $T_j: 25^\circ C, 125^\circ C, 150^\circ C$

figure 9. IGBT

Typical output characteristics

$$I_C = f(V_{CE})$$

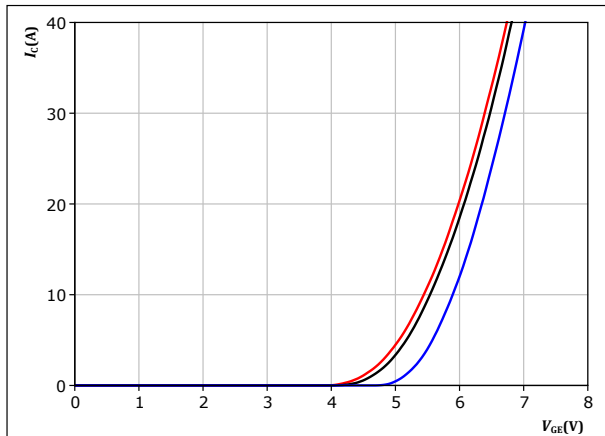


$t_p = 250 \mu s$
 $T_j = 150^\circ C$
 V_{GE} from 7 V to 17 V in steps of 1 V

figure 10. IGBT

Typical transfer characteristics

$$I_C = f(V_{GE})$$

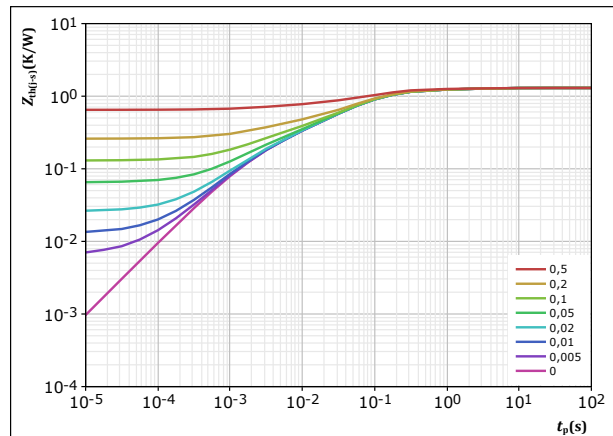


$t_p = 250 \mu s$
 $V_{CE} = 10 V$
 $T_j: 25^\circ C, 125^\circ C, 150^\circ C$

figure 11. IGBT

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D = t_p / T$
 $R_{th(j-s)} = 1,299 K/W$
IGBT thermal model values

$R (K/W)$	$\tau (s)$
$7,67E-02$	$2,84E+00$
$1,78E-01$	$3,36E-01$
$7,37E-01$	$7,35E-02$
$1,98E-01$	$9,72E-03$
$1,09E-01$	$1,65E-03$



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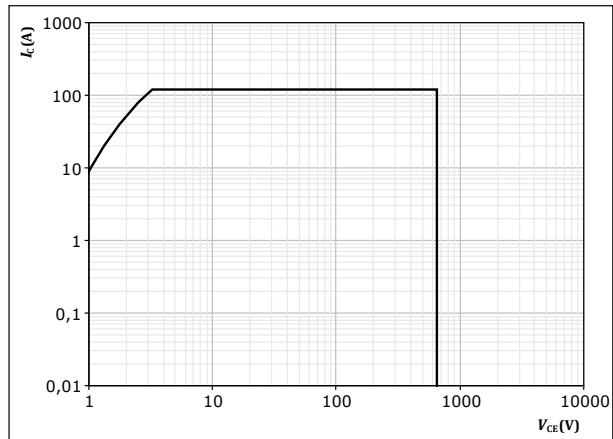
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PFC Switch Characteristics

figure 12. IGBT

Safe operating area

$$I_C = f(V_{CE})$$

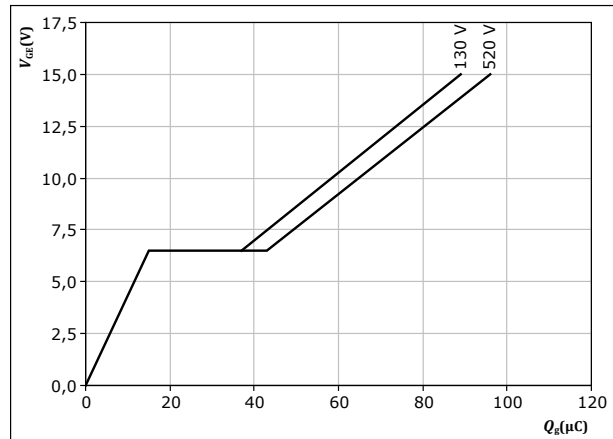


$D = \text{single pulse}$
 $T_s = 80 \text{ } ^\circ\text{C}$
 $V_{GE} = 15 \text{ V}$
 $T_j = T_{jmax}$

figure 13. IGBT

Gate voltage vs gate charge

$$V_{GE} = f(Q_g)$$



$I_C = 20 \text{ A}$
 $T_j = 25 \text{ } ^\circ\text{C}$



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PFC Diode Characteristics

figure 14. FWD

Typical forward characteristics

$$I_F = f(V_F)$$

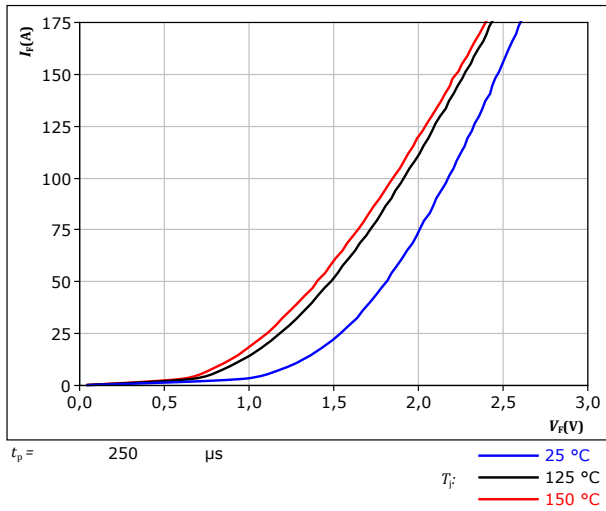
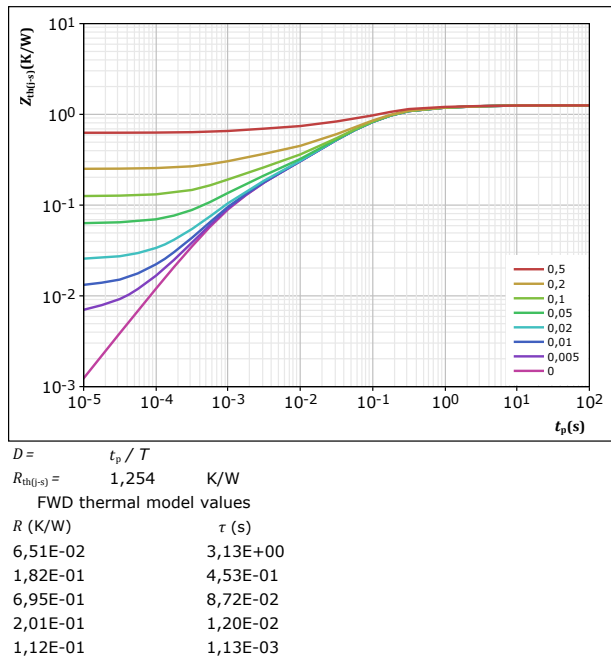


figure 15. FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D =$	t_p / T
$R_{th(j-s)} =$	1,254 K/W
FWD thermal model values	
R (K/W)	τ (s)
6,51E-02	3,13E+00
1,82E-01	4,53E-01
6,95E-01	8,72E-02
2,01E-01	1,20E-02
1,12E-01	1,13E-03



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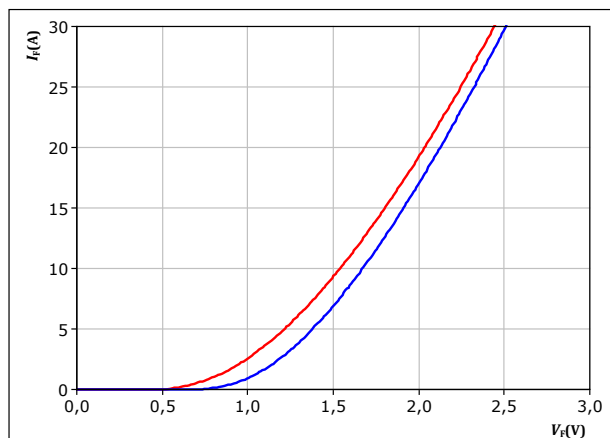
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PFC Sw. Protection Diode Characteristics

figure 16. FWD

Typical forward characteristics

$$I_F = f(V_F)$$

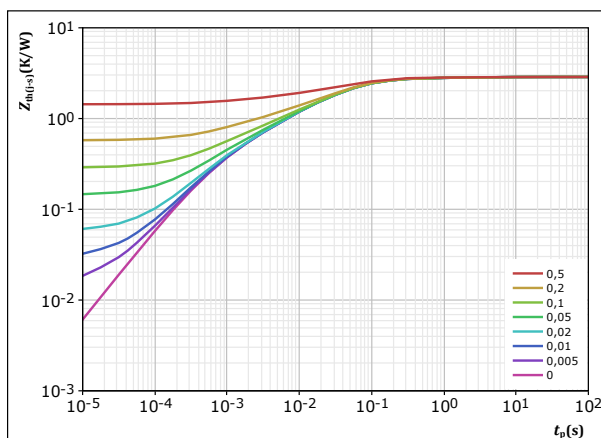


T_j : 25 °C
125 °C

figure 17. FWD

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D =$	t_p / T	
$R_{th(j-s)} =$	2,873	K/W
FWD thermal model values		
R (K/W)	τ (s)	
6,53E-02	3,94E+00	
1,48E-01	4,48E-01	
1,31E+00	5,96E-02	
7,32E-01	1,36E-02	
4,04E-01	2,79E-03	
2,11E-01	5,37E-04	



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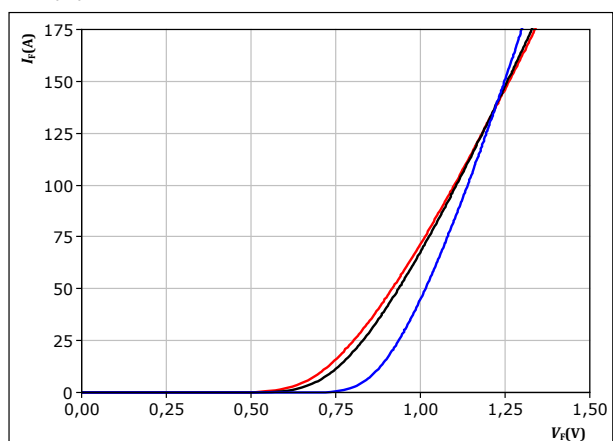
Rectifier Diode Characteristics

figure 18.

Rectifier

Typical forward characteristics

$$I_F = f(V_F)$$



$t_p = 250 \mu s$

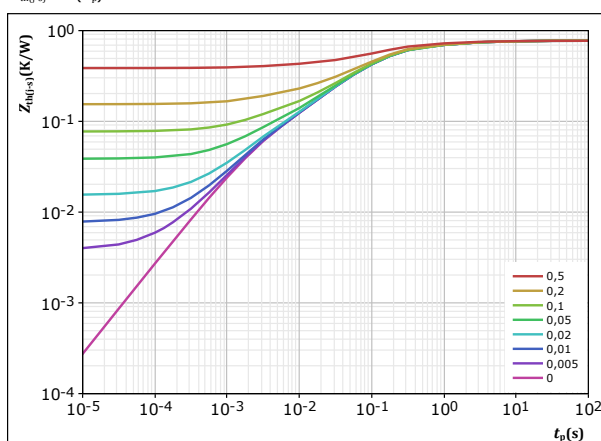
T_j :
— 25 °C
— 125 °C
— 150 °C

figure 19.

Rectifier

Transient thermal impedance as a function of pulse width

$$Z_{th(j-s)} = f(t_p)$$



$D =$	t_p / T	
$R_{th(j-s)} =$	0,772	K/W
Rectifier thermal model values		
R (K/W)	τ (s)	
2,82E-02	8,69E+00	
1,16E-01	1,22E+00	
4,16E-01	1,44E-01	
1,62E-01	2,97E-02	
5,02E-02	2,64E-03	



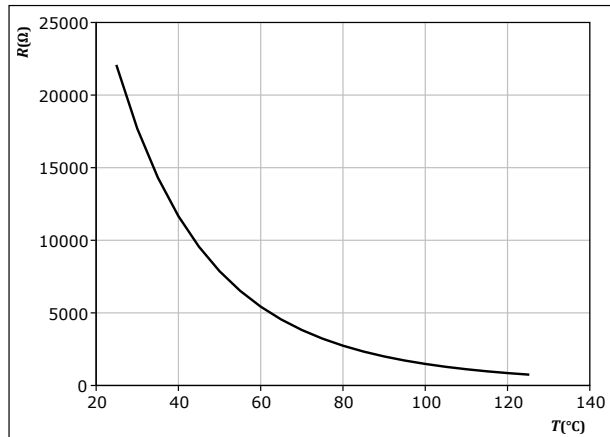
Vincotech

Thermistor Characteristics

figure 20. Thermistor

Typical NTC characteristic as function of temperature

$$R_T = f(T)$$





Vincotech

10-P106PPA050SJ-PD54B09Y

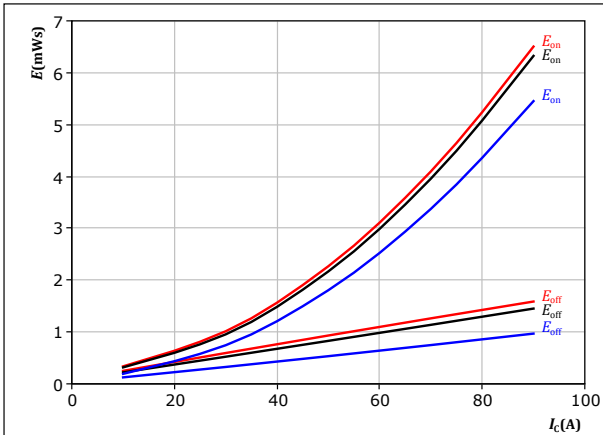
datasheet

Inverter Switching Characteristics

figure 21. IGBT

Typical switching energy losses as a function of collector current

$$E = f(I_c)$$



With an inductive load at

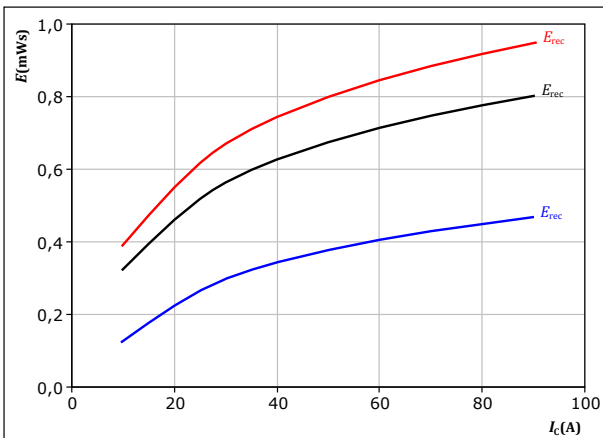
$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 8$ Ω
 $R_{goff} = 8$ Ω

T_j :
— 25 °C
— 125 °C
— 150 °C

figure 23. FWD

Typical reverse recovered energy loss as a function of collector current

$$E_{rec} = f(I_c)$$



With an inductive load at

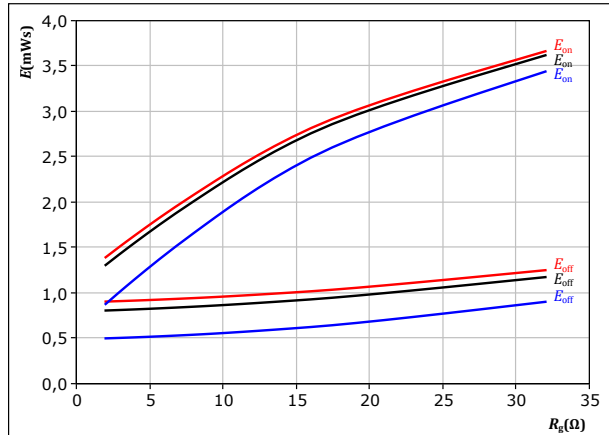
$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 8$ Ω

T_j :
— 25 °C
— 125 °C
— 150 °C

figure 22. IGBT

Typical switching energy losses as a function of IGBT turn on gate resistor

$$E = f(R_g)$$



With an inductive load at

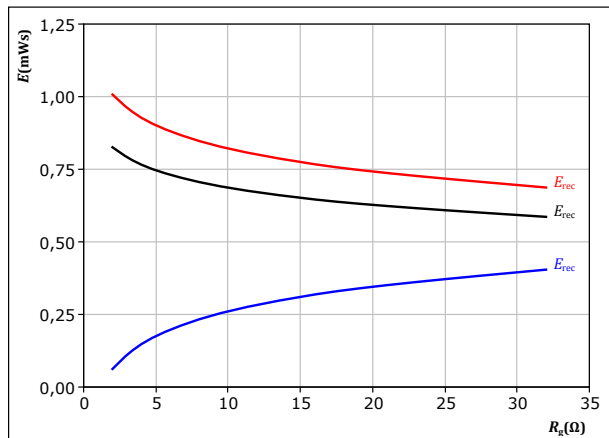
$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_c = 50$ A

T_j :
— 25 °C
— 125 °C
— 150 °C

figure 24. FWD

Typical reverse recovered energy loss as a function of IGBT turn on gate resistor

$$E_{rec} = f(R_g)$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_c = 50$ A

T_j :
— 25 °C
— 125 °C
— 150 °C



Vincotech

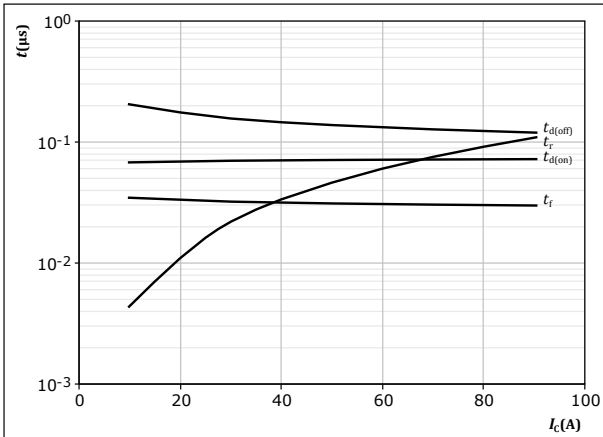
10-P106PPA050SJ-PD54B09Y datasheet

Inverter Switching Characteristics

figure 25.

IGBT

Typical switching times as a function of collector current
 $t = f(I_C)$



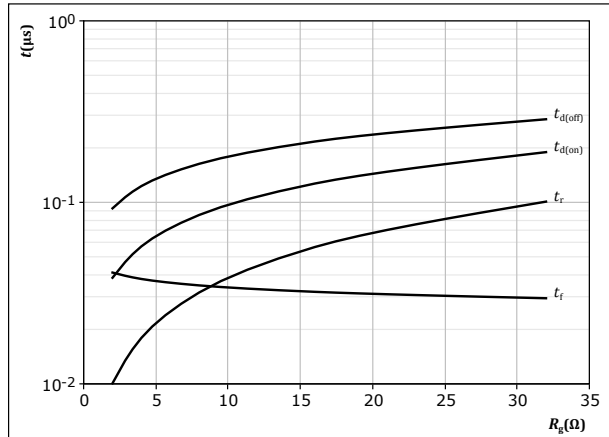
With an inductive load at

$T_j = 150$ °C
 $V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 8$ Ω
 $R_{goff} = 8$ Ω

figure 26.

IGBT

Typical switching times as a function of IGBT turn on gate resistor
 $t = f(R_g)$



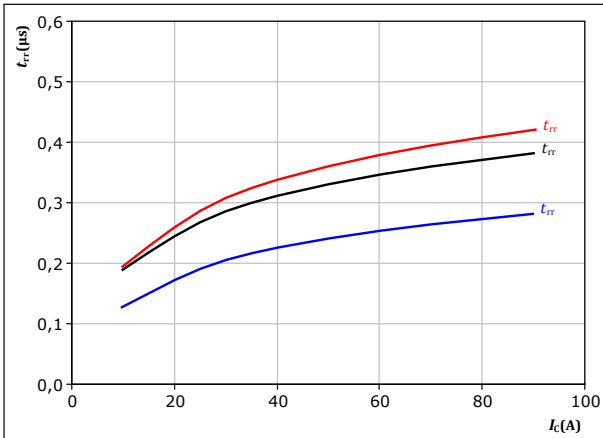
With an inductive load at

$T_j = 150$ °C
 $V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_C = 50$ A

figure 27.

FWD

Typical reverse recovery time as a function of collector current
 $t_{rr} = f(I_C)$



With an inductive load at

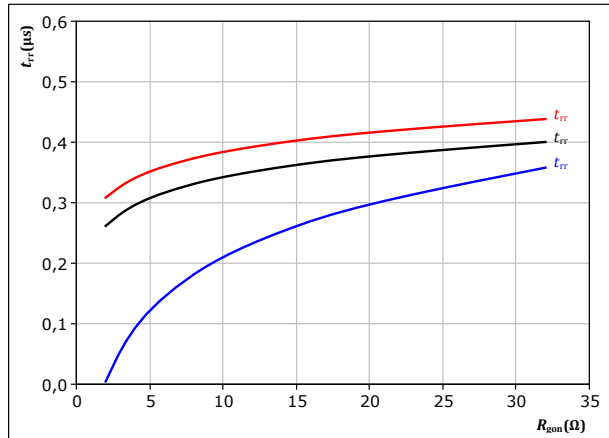
$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 8$ Ω

T_j :
— 25 °C
— 125 °C
— 150 °C

figure 28.

FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor
 $t_{rr} = f(R_{gon})$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_C = 50$ A

T_j :
— 25 °C
— 125 °C
— 150 °C



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10-P106PPA050SJ-PD54B09Y datasheet

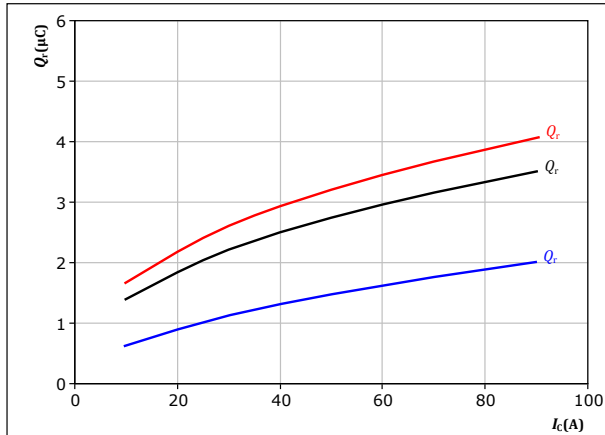
Inverter Switching Characteristics

figure 29.

FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 8$ Ω

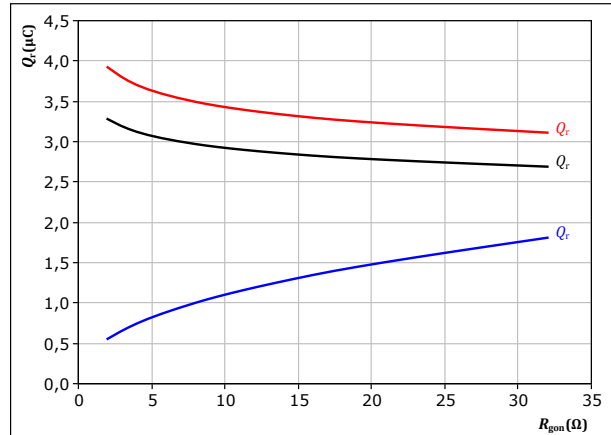
T_j :
— 25 °C
— 125 °C
— 150 °C

figure 30.

FWD

Typical recovered charge as a function of IGBT turn on gate resistor

$$Q_r = f(R_{gon})$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_c = 50$ A

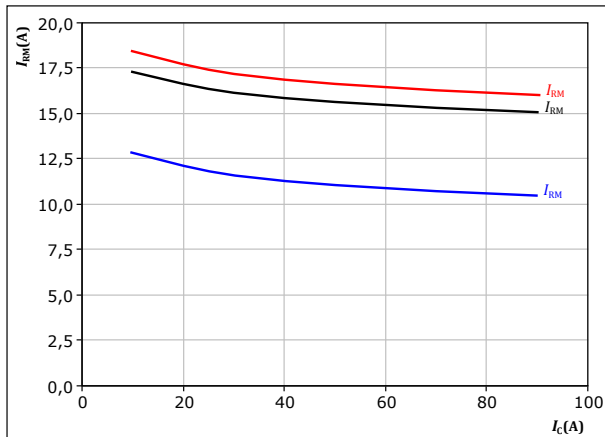
T_j :
— 25 °C
— 125 °C
— 150 °C

figure 31.

FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 8$ Ω

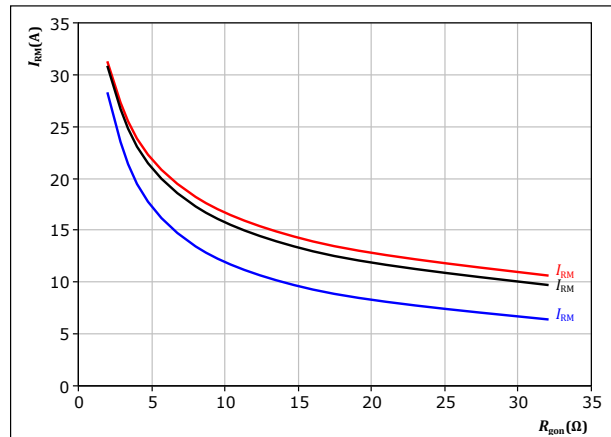
T_j :
— 25 °C
— 125 °C
— 150 °C

figure 32.

FWD

Typical peak reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RM} = f(R_{gon})$$



With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_c = 50$ A

T_j :
— 25 °C
— 125 °C
— 150 °C



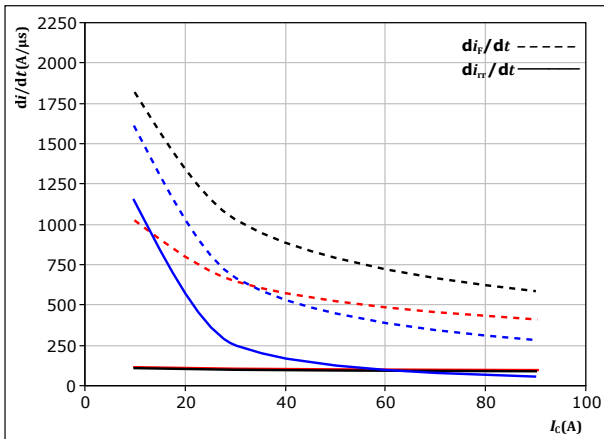
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10-P106PPA050SJ-PD54B09Y
datasheet

Inverter Switching Characteristics

figure 33. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_r/dt = f(I_C)$



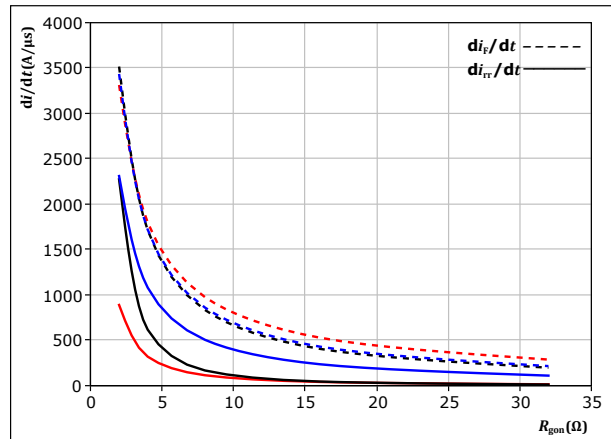
With an inductive load at

$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $R_{gon} = 8$ Ω

T_j : 25 °C (blue), 125 °C (black), 150 °C (red)

figure 34. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor
 $di_f/dt, di_r/dt = f(R_{gon})$



With an inductive load at

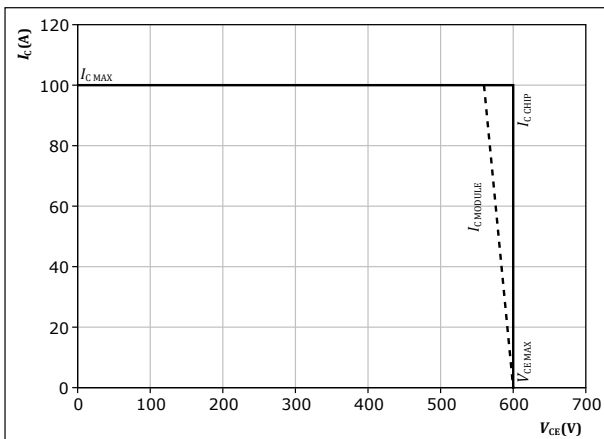
$V_{CE} = 350$ V
 $V_{GE} = \pm 15$ V
 $I_C = 50$ A

T_j : 25 °C (blue), 125 °C (black), 150 °C (red)

figure 35. IGBT

Reverse bias safe operating area

$I_C = f(V_{CE})$



At $T_j = 150$ °C

$R_{gon} = 8$ Ω
 $R_{goff} = 8$ Ω



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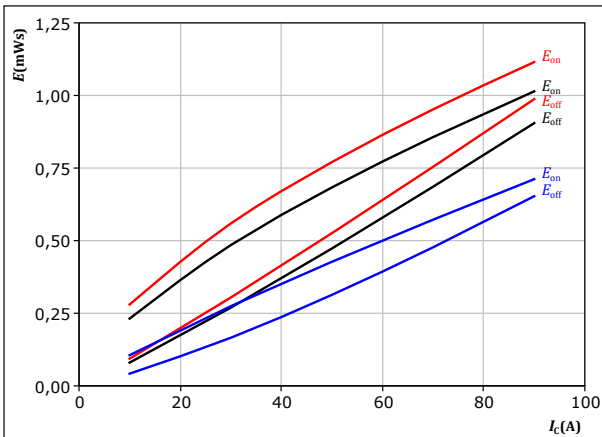
PFC Switching Characteristics

figure 36.

IGBT

Typical switching energy losses as a function of collector current

$$E = f(I_C)$$



With an inductive load at

$V_{CE} = 400$ V
 $V_{GE} = 0/15$ V
 $R_{gon} = 4$ Ω
 $R_{goff} = 4$ Ω

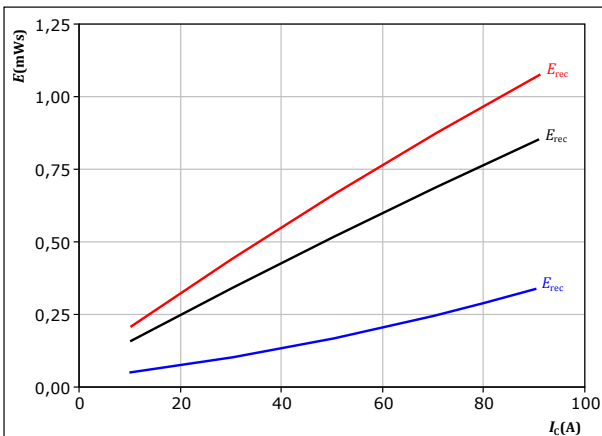
T_j : 25 °C
125 °C
150 °C

figure 38.

FWD

Typical reverse recovered energy loss as a function of collector current

$$E_{rec} = f(I_C)$$



With an inductive load at

$V_{CE} = 400$ V
 $V_{GE} = 0/15$ V
 $R_{gon} = 4$ Ω

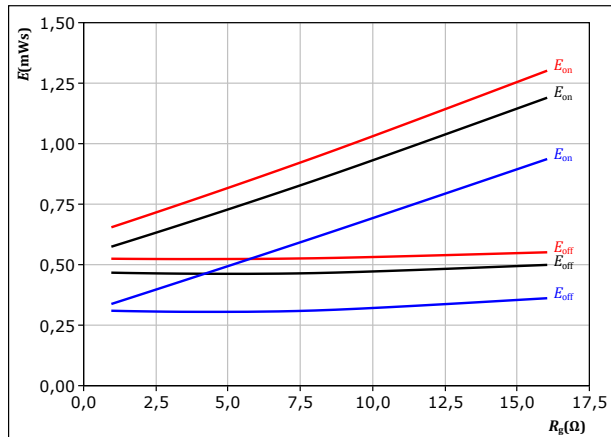
T_j : 25 °C
125 °C
150 °C

figure 37.

IGBT

Typical switching energy losses as a function of IGBT turn on gate resistor

$$E = f(R_g)$$



With an inductive load at

$V_{CE} = 400$ V
 $V_{GE} = 0/15$ V
 $I_C = 50$ A

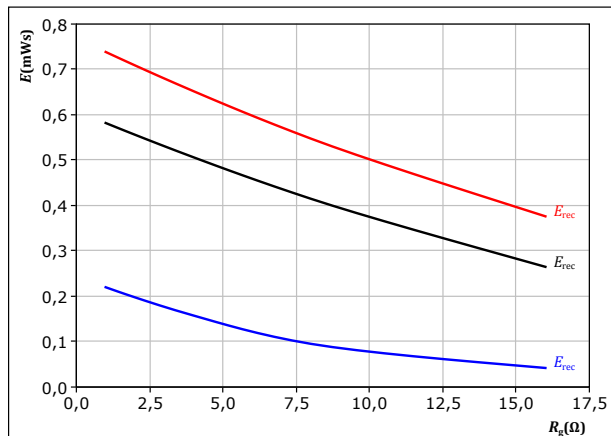
T_j : 25 °C
125 °C
150 °C

figure 39.

FWD

Typical reverse recovered energy loss as a function of IGBT turn on gate resistor

$$E_{rec} = f(R_g)$$



With an inductive load at

$V_{CE} = 400$ V
 $V_{GE} = 0/15$ V
 $I_C = 50$ A

T_j : 25 °C
125 °C
150 °C



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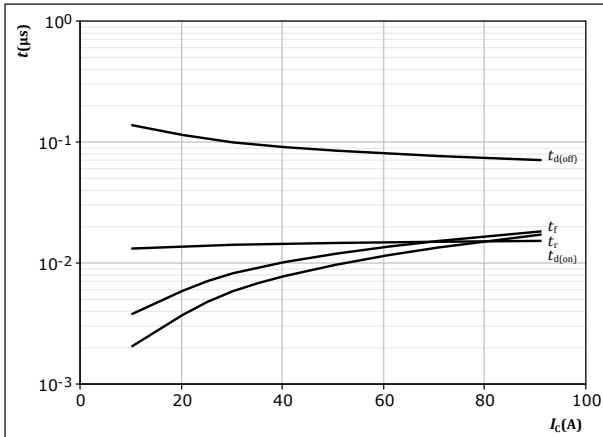
10-P106PPA050SJ-PD54B09Y datasheet

PFC Switching Characteristics

figure 40.

IGBT

Typical switching times as a function of collector current
 $t = f(I_C)$



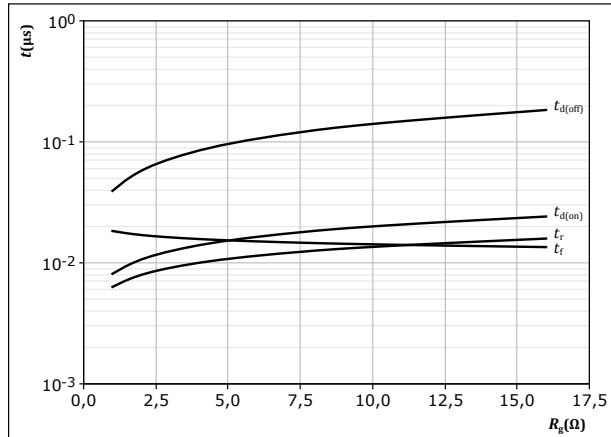
With an inductive load at

$T_j = 150$ °C
 $V_{CE} = 400$ V
 $V_{GE} = 0/15$ V
 $R_{gon} = 4$ Ω
 $R_{goff} = 4$ Ω

figure 41.

IGBT

Typical switching times as a function of IGBT turn on gate resistor
 $t = f(R_g)$



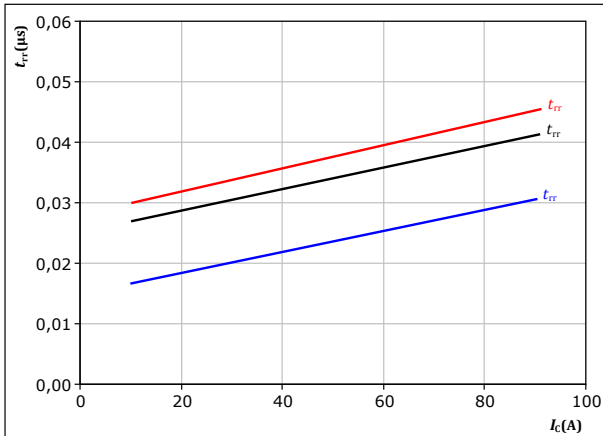
With an inductive load at

$T_j = 150$ °C
 $V_{CE} = 400$ V
 $V_{GE} = 0/15$ V
 $I_C = 50$ A

figure 42.

FWD

Typical reverse recovery time as a function of collector current
 $t_{rr} = f(I_C)$



With an inductive load at

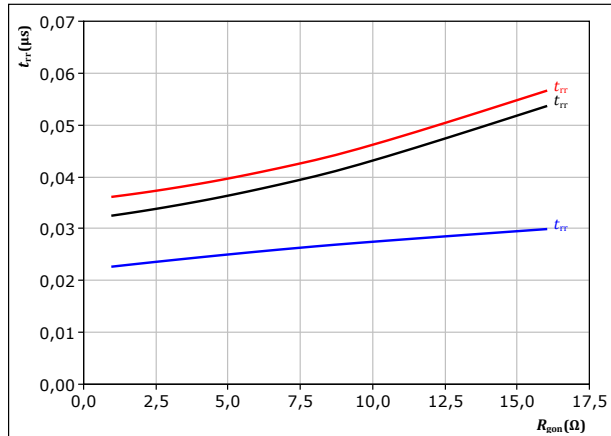
$V_{CE} = 400$ V
 $V_{GE} = 0/15$ V
 $R_{gon} = 4$ Ω

T_j : 25 °C
125 °C
150 °C

figure 43.

FWD

Typical reverse recovery time as a function of IGBT turn on gate resistor
 $t_{rr} = f(R_{gon})$



With an inductive load at

$V_{CE} = 400$ V
 $V_{GE} = 0/15$ V
 $I_C = 50$ A

T_j : 25 °C
125 °C
150 °C



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10-P106PPA050SJ-PD54B09Y datasheet

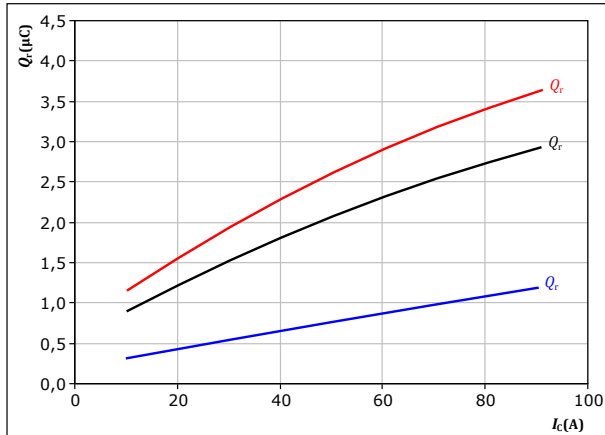
PFC Switching Characteristics

figure 44.

FWD

Typical recovered charge as a function of collector current

$$Q_r = f(I_c)$$



With an inductive load at

$V_{CE} = 400$ V
 $V_{GE} = 0/15$ V
 $R_{gon} = 4$ Ω

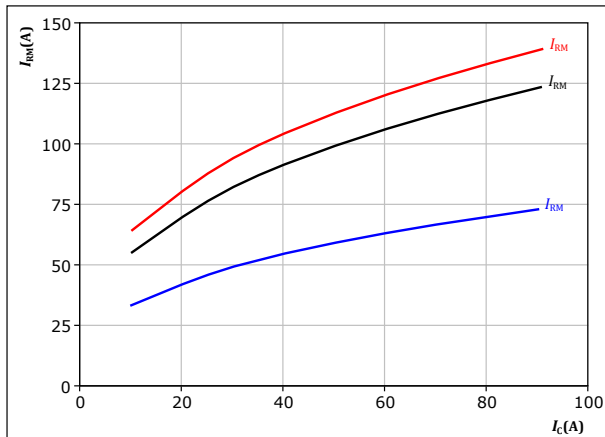
T_j :
— 25 °C
— 125 °C
— 150 °C

figure 46.

FWD

Typical peak reverse recovery current as a function of collector current

$$I_{RM} = f(I_c)$$



With an inductive load at

$V_{CE} = 400$ V
 $V_{GE} = 0/15$ V
 $R_{gon} = 4$ Ω

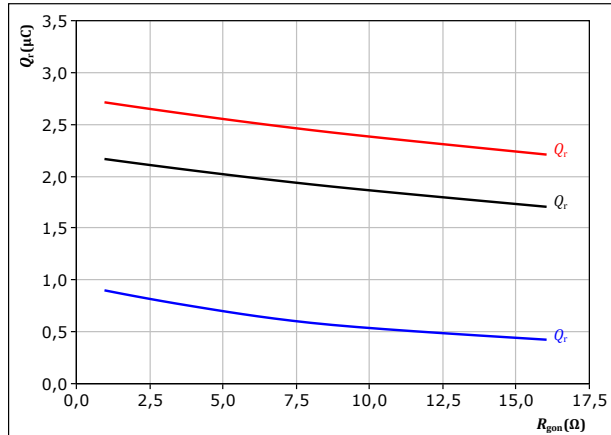
T_j :
— 25 °C
— 125 °C
— 150 °C

figure 45.

FWD

Typical recovered charge as a function of IGBT turn on gate resistor

$$Q_r = f(R_{gon})$$



With an inductive load at

$V_{CE} = 400$ V
 $V_{GE} = 0/15$ V
 $I_c = 50$ A

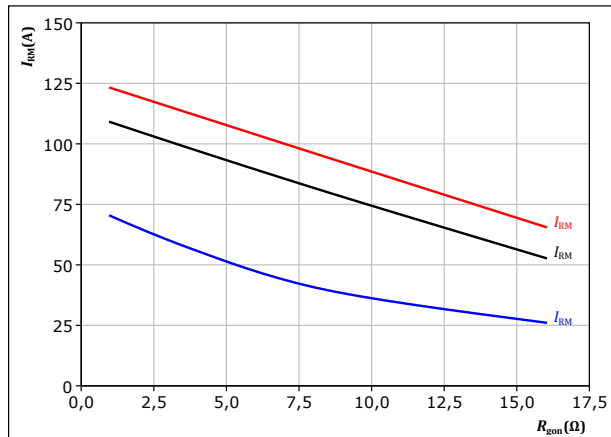
T_j :
— 25 °C
— 125 °C
— 150 °C

figure 47.

FWD

Typical peak reverse recovery current as a function of IGBT turn on gate resistor

$$I_{RM} = f(R_{gon})$$



With an inductive load at

$V_{CE} = 400$ V
 $V_{GE} = 0/15$ V
 $I_c = 50$ A

T_j :
— 25 °C
— 125 °C
— 150 °C



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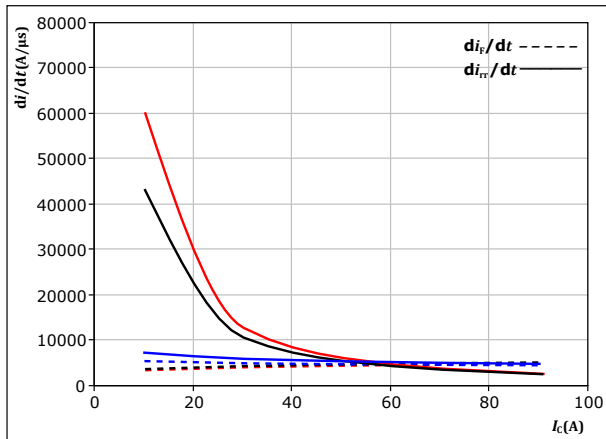
10-P106PPA050SJ-PD54B09Y

datasheet

PFC Switching Characteristics

figure 48. FWD

Typical rate of fall of forward and reverse recovery current as a function of collector current
 $di_f/dt, di_r/dt = f(I_C)$



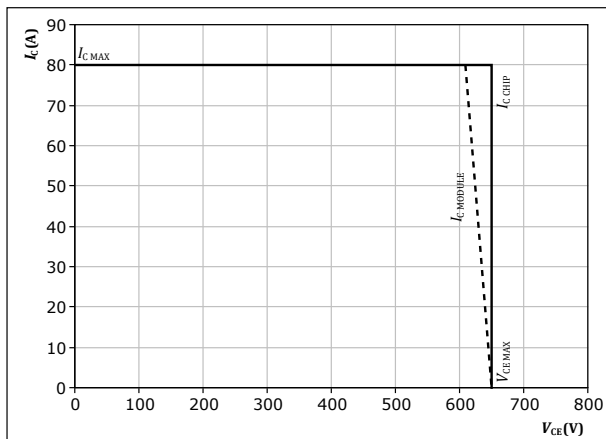
With an inductive load at

$V_{CE} = 400$ V
 $V_{GE} = 0/15$ V
 $R_{gon} = 4$ Ω
 $T_j = 25$ °C
 $T_j = 125$ °C
 $T_j = 150$ °C

figure 50. IGBT

Reverse bias safe operating area

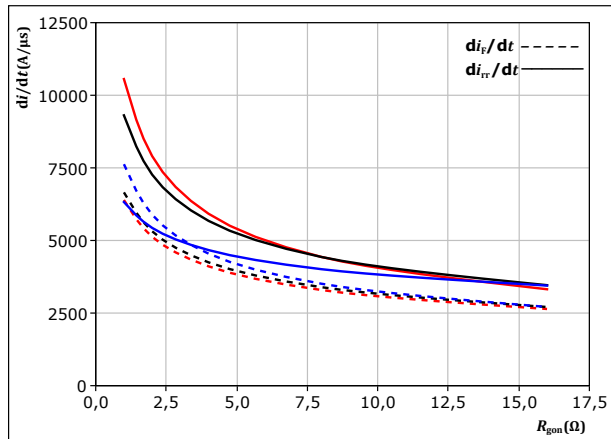
$I_C = f(V_{CE})$



At $T_j = 150$ °C
 $R_{gon} = 4$ Ω
 $R_{goff} = 4$ Ω

figure 49. FWD

Typical rate of fall of forward and reverse recovery current as a function of turn on gate resistor
 $di_f/dt, di_r/dt = f(R_{gon})$



With an inductive load at

$V_{CE} = 400$ V
 $V_{GE} = 0/15$ V
 $I_C = 50$ A
 $T_j = 25$ °C
 $T_j = 125$ °C
 $T_j = 150$ °C



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Switching Definitions

figure 51. IGBT

Turn-off Switching Waveforms & definition of t_{doff} , t_{Eoff} (t_{Eoff} = integrating time for E_{off})

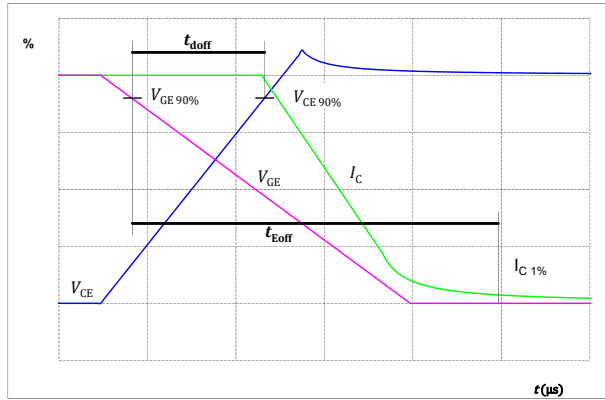


figure 52. IGBT

Turn-on Switching Waveforms & definition of t_{don} , t_{Eon} (t_{Eon} = integrating time for E_{on})

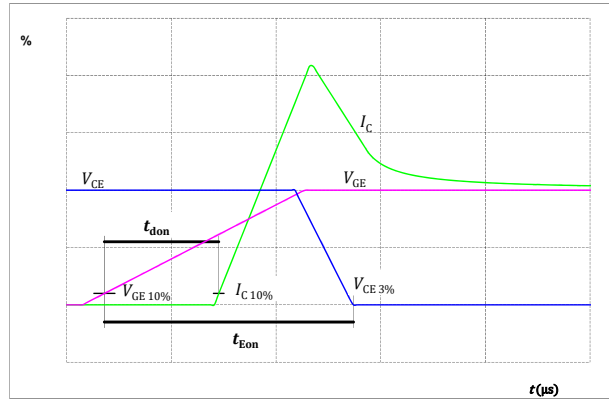


figure 53. IGBT

Turn-off Switching Waveforms & definition of t_f

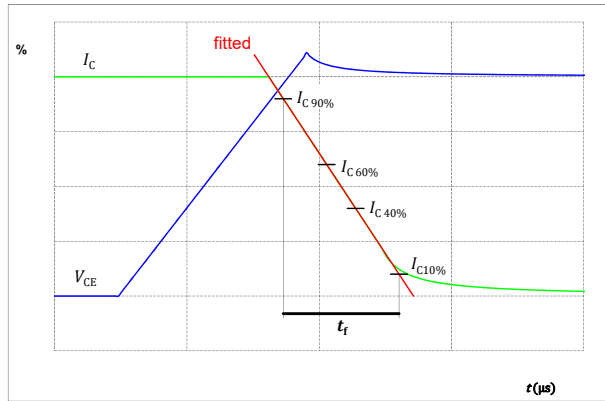
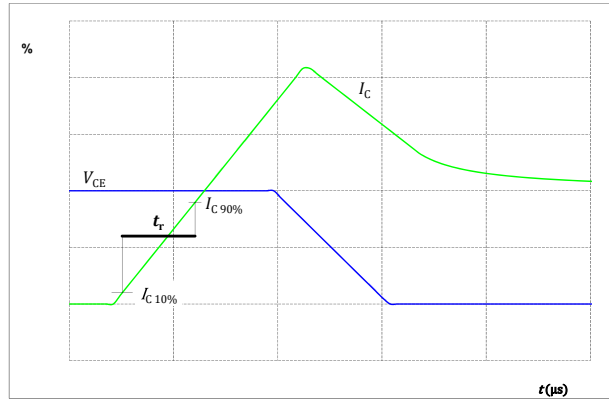


figure 54. IGBT

Turn-on Switching Waveforms & definition of t_r





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Switching Definitions

figure 55.

FWD

Turn-off Switching Waveforms & definition of t_{rr}

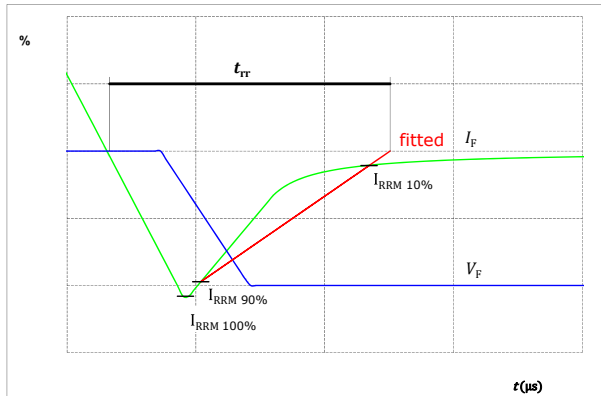
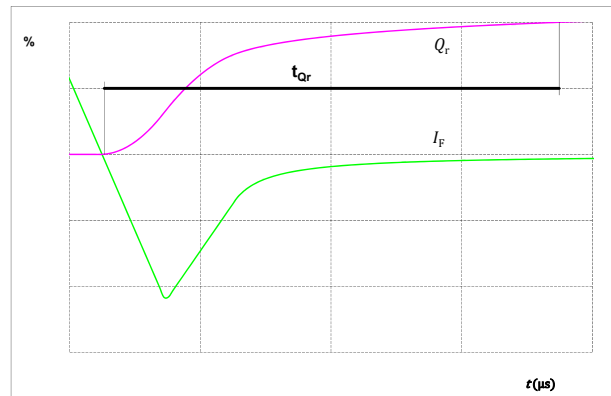


figure 56.

FWD


Turn-on Switching Waveforms & definition of t_{Qr} (t_{Qr} = integrating time for Q_r)





datasheet

Ordering Code	
Version	Ordering Code
Without thermal paste	10-P106PPA050SJ-PD54B09Y
With thermal paste (5,2 W/mK, PTM6000HV)	10-P106PPA050SJ-PD54B09Y-/7/
With thermal paste (3,4 W/mK, PSX-P7)	10-P106PPA050SJ-PD54B09Y-/3/

Marking							
	Text	Name		Date code	UL & VIN	Lot	Serial
		NN-NNNNNNNNNNNNNN- TTTTTIVV		WWYY	UL VIN	LLLL	SSSS
	Datamatrix	Type&Ver	Lot number	Serial	Date code		
	TTTTTIVV	LLLL	SSSS	WWYY			

Pin table [mm]			
Pin	X	Y	Function
1	not assembled		
2	not assembled		
3	45,5	0	DC-Rect
4	42,8	0	DC-Rect
5	38,5	0	PFC-
6	38,5	3	S1sh2
7	38,5	6	S2sh2
8	31,8	1,2	PFC+
9	31,8	3,9	PFC+
10	25,1	1,9	S1sh3
11	23,1	4,9	S2sh3
12	22,1	0	PFC-
13	19,1	0	Therm1
14	19,1	3	Therm2
15	15	0	G11
16	12	0	DC-1
17	9	0	G13
18	6	0	DC-2
19	3	0	G15
20	0	0	DC-3
21	0	15,15	DC+Inv
22	0	17,85	DC+Inv
23	0	25,5	G16
24	0	28,5	Ph3
25	7,7	25,5	G14
26	7,7	28,5	Ph2
27	15,4	25,5	G12
28	15,4	28,5	Ph1
29	21,7	16,3	G27
30	21,7	19,3	S27
31	23,4	28,5	PFC2
32	31,1	28,5	PFC1
33	32,9	19,3	G25
34	35,9	19,3	S25
35	39,1	28,5	DC+Rect
36	41,8	28,5	DC+Rect
37	49,8	28,5	ACIn1
38	52,5	28,5	ACIn1
39	44,3	17,2	ACIn2
40	44,3	14,45	ACIn2

Outline

center of press-fit pin head
pin head type "Y" PCB plated through-hole Ø0.15 mm ±0.09 / -0.06
for further PCB design rules refer to the latest handling instruction

105
262

105
262

Y

26,25

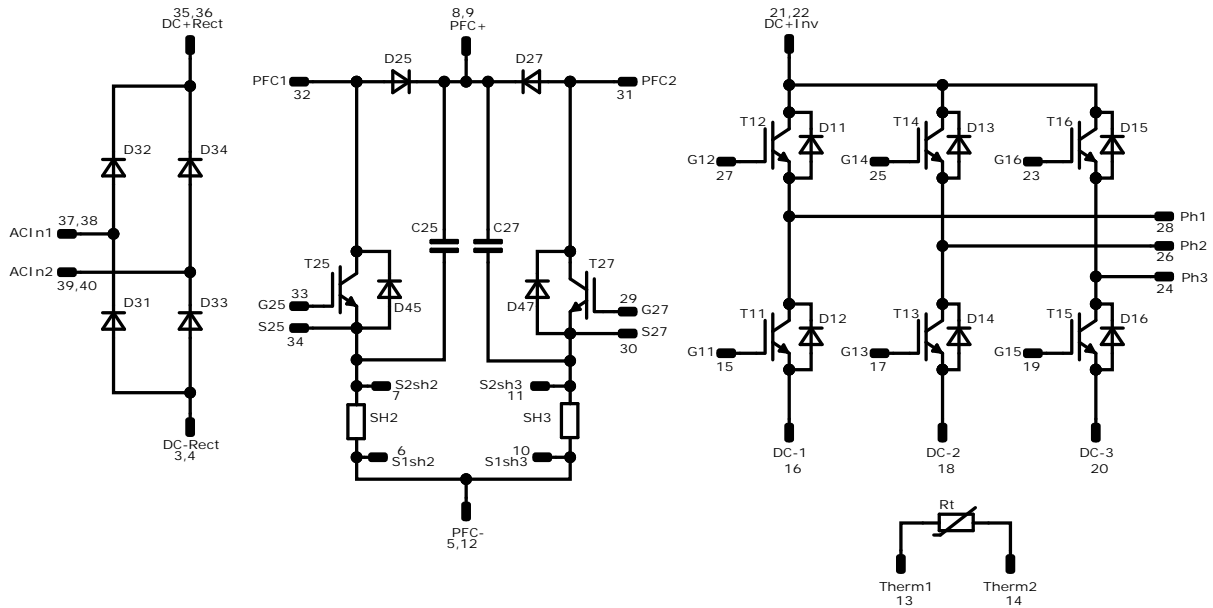
Tolerance of pin positions: ±0.5mm at the end of pins.
Dimension of coordinate axis is only offset without tolerance



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10-P106PPA050SJ-PD54B09Y
datasheet

Pinout




Identification

ID	Component	Voltage	Current	Function	Comment
T11, T12, T13, T14, T15, T16	IGBT	600 V	50 A	Inverter Switch	
D11, D12, D13, D14, D15, D16	FWD	600 V	30 A	Inverter Diode	
T25, T27	IGBT	650 V	40 A	PFC Switch	
D25, D27	FWD	600 V	60 A	PFC Diode	
D45, D47	FWD	650 V	10 A	PFC Sw. Protection Diode	
D31, D32, D33, D34	Rectifier	1600 V	60 A	Rectifier Diode	
SH2, SH3	Shunt			PFC Shunt	
C25, C27	Capacitor	630 V		Capacitor (PFC)	
Rt	Thermistor			Thermistor	



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10-P106PPA050SJ-PD54B09Y
datasheet

Packaging instruction				
Standard packaging quantity (SPQ) 100	>SPQ	Standard	<SPQ	Sample
Handling instruction				
Handling instructions for <i>flow 1</i> packages see vincotech.com website.				
Package data				
Package data for <i>flow 1</i> packages see vincotech.com website.				
Vincotech thermistor reference				
See Vincotech thermistor reference table at vincotech.com website.				
UL recognition and file number				
This device is certified according to UL 1557 standard, UL file number E192116. For more information see vincotech.com website.				

Document No.:	Date:	Modification:	Pages
10-P106PPA050SJ-PD54B09Y-D3-14	2 May. 2023	PFC Switch changed	

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2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.